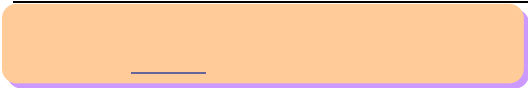


Sn50/Pb50 SnPbBi

1 0.4mm  
 2 12  
 3  
 4  
 5  
 6 --- PCB  
 7 ICT  
 8 Paste in hole

		85~91wt% ± 0.5	
		9~15wt% ± 0.5	
		200 Pa.s ± 10% Malcolm (10rpm,2) )	T3,90% metal for printing
		80 Pa.s ± 10% Malcolm (10rpm,2) )	T4,87% metal for syringe
		0.55 ± 0.05	In house
		90%	Copper plate(Sn63,90% metal)
			J-STD-005
			In house
Vs		48gF 0	
		56gF 2 Ä	



1

T3 mesh -325/+500 25~45μ m

Fine pitch

2

1) “ ”

0~10

200

4

2)

3

1 ;

3



有铅免洗

0.4mm

0.12mm



有铅免洗

80%

	60 ~ 90HS
	45 <sup>0</sup> ~ 60 <sup>0</sup>
	2 ~ 4 × 10 <sup>5</sup> pa
	20 ~ 40mm/sec 15 ~ 20mm/sec 50 ~ 100mm/sec
	25 ± 3 40 ~ 70%



\*

\*



\*

PCB

PCB

A5

200g

B5

300g

A4

400g

4

4

5

6

此有铅



500g

PE

20

35



0 ~10

•

•

0

6



MSDS

